National Semiconductor

July 2004

DS8922/DS8922A/DS8923A TRI-STATE® RS-422 Dual Differential Line Driver and Receiver Pairs

General Description

The DS8922/22A and DS8923A are Dual Differential Line Driver and Receiver pairs. These devices are designed specifically for applications meeting the ST506, ST412 and ESDI Disk Drive Standards. In addition, the devices meet the requirements of the EIA Standard RS-422.

These devices offer an input sensitivity of 200 mV over a ±7V common mode operating range. Hysteresis is incorporated (typically 70 mV) to improve noise margin for slowly changing input waveforms. An input fail-safe circuit is provided such that if the receiver inputs are open the output assumes the logical one state.

The DS8922A and DS8923A drivers are designed to provide unipolar differential drive to twisted pair or parallel wire transmission lines. Complementary outputs are logically ANDed and provide an output skew of 0.5 ns (typ.) with propagation delays of 12 ns.

Both devices feature TRI-STATE outputs. The DS8922/22A have independent control functions common to a driver and receiver pair. The DS8923A has separate driver and receiver control functions.

Power up/down circuitry is featured which will TRI-STATE the outputs and prevent erroneous glitches on the transmission lines during system power up or power down operation.

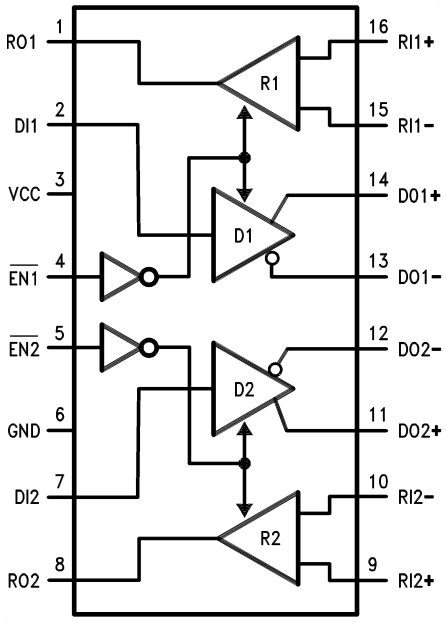
The DS8922/22A and DS8923A are designed to be compatible with TTL and CMOS.

Features

- 12 ns typical propagation delay
- Output skew — ±0.5 ns typical
- Meets the requirements of EIA Standard RS-422
- Complementary Driver Outputs
- High differential or common-mode input voltage ranges of ±7V
- ±0.2V receiver sensitivity over the input voltage range
- Receiver input fail-safe circuitry
- Receiver input hysteresis — 70 mV typical
- Glitch free power up/down
- TRI-STATE outputs

Connection Diagrams

DS8922A Dual-In-Line



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Order Number DS8922M, DS8922N, DS8922AM or DS8922AN
See NS Package Number M16A or N16E

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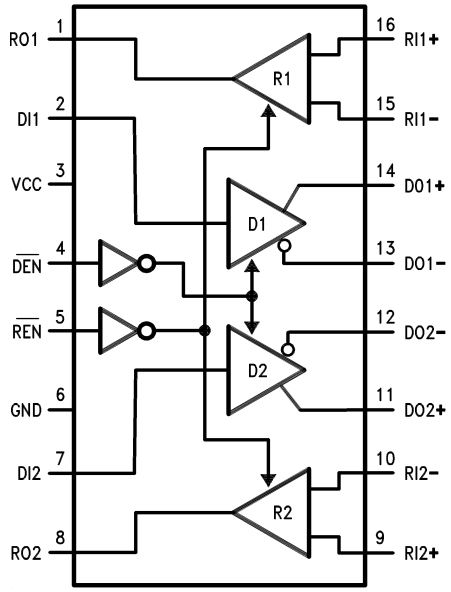
Connection Diagrams (Continued)

DS8923A Dual-In-Line



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Order Number DS8923AM, DS8923AN,
See NS Package Number M16A or N16E

DS8922/22A

$\overline{EN1}$	$\overline{EN2}$	RO1	RO2	DO1	DO2
0	0	ACTIVE	ACTIVE	ACTIVE	ACTIVE
1	0	HI-Z	ACTIVE	HI-Z	ACTIVE
0	1	ACTIVE	HI-Z	ACTIVE	HI-Z
1	1	HI-Z	HI-Z	HI-Z	HI-Z

DS8923A

$\overline{DEN}$	$\overline{REN}$	RO1	RO2	DO1	DO2
0	0	ACTIVE	ACTIVE	ACTIVE	ACTIVE
1	0	ACTIVE	ACTIVE	HI-Z	HI-Z
0	1	HI-Z	HI-Z	ACTIVE	ACTIVE
1	1	HI-Z	HI-Z	HI-Z	HI-Z

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage	7V
Drive Input Voltage	−0.5V to +7V
Output Voltage	5.5V
Receiver Output Sink Current	50 mA
Receiver Input Voltage	±10V
Differential Input Voltage	±12V
Maximum Package Power Dissipation @ +25˚C	
M Package	1300 mW
N Package	1450 mW
Derate M Package 10.4 mW/˚C above +25˚C	
Derate N Package 11.6 mW/˚C above +25˚C	
Storage Temperature Range	−65˚C to +165˚C
Lead Temp. (Soldering, 4 seconds)	260˚C
ESD Rating (HBM)	2000V+

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage	4.5	5.5	V
Temperature (T_A)	0	70	˚C

DS8922/22A and DS8923A Electrical Characteristics (Notes 2, 3, 4)

Symbol	Conditions		Min	Typ	Max	Units
RECEIVER						
V_{TH}	$-7V \le V_{CM} \le +7V$		−200	±35	+200	mV
V_{HYST}	$-7V \le V_{CM} \le +7V$		15	70		mV
R_{IN}	V_{IN} = −7V, +7V (Other Input = GND)		4.0	6.0		kΩ
I_{IN}	V_{IN} = 10V				3.25	mA
	V_{IN} = −10V				−3.25	mA
V_{OH}	V_{CC} = MIN, I_{OH} = − 400 µA		2.5			V
V_{OL}	V_{CC} = MAX, I_{OL} = 8 mA				0.5	V
I_{SC}	V_{CC} = MAX, V_{OUT} = 0V		−15		−100	mA
DRIVER						
V_{OH}	V_{CC} = MIN, I_{OH} = −20 mA		2.5			V
V_{OL}	V_{CC} = MIN, I_{OL} = +20 mA				0.5	V
I_{OFF}	V_{CC} = 0V, V_{OUT} = 5.5V				100	µA
$\lvert VT\rvert - \lvert \overline{VT} \rvert$					0.4	V
VT			2.0			V
$\lvert V_{OS} - \overline{V_{OS}} \rvert$					0.4	V
I_{SC}	V_{CC} = MAX, V_{OUT} = 0V		−30		−150	mA
DRIVER and RECEIVER						
I_{OZ} TRI-STATE Leakage	V_{CC} = MAX	V_{OUT} = 2.5V			50	µA
		V_{OUT} = 0.4V			−50	µA
I_{CC}	V_{CC} = MAX	ACTIVE			76	mA
		TRI-STATE			78	mA
DRIVER and ENABLE INPUTS						
V_{IH}			2.0			V
V_{IL}					0.8	V
I_{IL}	V_{CC} = MAX, V_{IN} = 0.4V			−40	−200	µA
I_{IH}	V_{CC} = MAX, V_{IN} = 2.7V				20	µA
I_I	V_{CC} = MAX, V_{IN} = 7.0V				100	µA
V_{CL}	V_{CC} = MIN, I_{IN} = −18 mA				−1.5	V

Receiver Switching Characteristics

(*Figures 1, 2, 3*)

Parameter	Conditions	Min	Typ	Max		Units
				8922	8922A/23A	
T_{pLH}	CL = 30 pF		12	22.5	20	ns
T_{pHL}	CL = 30 pF		12	22.5	20	ns
$\lvert T_{pLH} - T_{pHL} \rvert$	CL = 30 pF		0.5	5	3.5	ns
Skew (Channel to Channel)	CL = 30 pF		0.5	3.0	2.0	ns
T_{pLZ}	CL = 15 pF S2 Open		15			ns
T_{pHZ}	CL = 15 pF S1 Open		15			ns
T_{pZL}	CL = 30 pF S2 Open		20			ns
T_{pZH}	CL = 30 pF S1 Open		20			ns

Driver Switching Characteristics

Parameter	Conditions	Min	Typ	Max		Units
				8922	8922A/23A	
SINGLE ENDED CHARACTERISTICS (*Figures 4, 5, 6, 8*)						
T_{pLH}	CL = 30 pF		12	15	15	ns
T_{pHL}	CL = 30 pF		12	15	15	ns
T_{TLH}	CL = 30 pF		5	10	10	ns
T_{THL}	CL = 30 pF		5	10	10	ns
$\lvert T_{pLH} - T_{pHL} \rvert$	CL = 30 pF		0.5			ns
Skew	CL = 30 pF (Note 5)		0.5	5	3.5	ns
Skew (Channel to Channel)			0.5	3.0	2.0	ns
T_{pLZ}	CL = 30 pF		15			ns
T_{pHZ}	CL = 30 pF		15			ns
T_{pZL}	CL = 30 pF		20			ns
T_{pZH}	CL = 30 pF		20			ns
DIFFERENTIAL SWITCHING CHARACTERISTICS (Note 6), (*Figure 4*)						
T_{pLH}	CL = 30 pF		12	15	15	ns
T_{pHL}	CL = 30 pF		12	15	15	ns
$\lvert T_{pLH} - T_{pHL} \rvert$	CL = 30 pF		0.5	6.0	2.75	ns

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The Table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: All currents into device pins are shown as positive values; all currents out of the device are shown as negative; all voltages are referenced to ground unless otherwise specified. All values shown as max or min are classified on absolute value basis.

Note 3: All typical values are V_{CC} = 5V, T_A = 25˚C.

Note 4: Only one output at a time should be shorted.

Note 5: Difference between complementary outputs at the 50% point.

Note 6: Differential Delays are defined as calculated results from single ended rise and fall time measurements. This approach in establishing AC performance specifications has been taken due to limitations of available Automatic Test Equipment (ATE).

The calculated ATE results assume a linear transition between measurement points and are a result of the following equations:

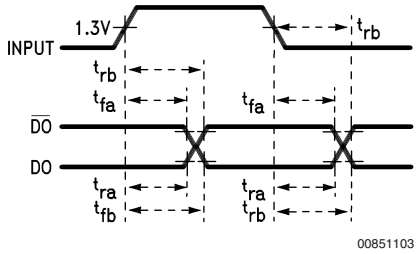
$$Tcp = \frac{(Tfb \times Trb) - (Tra \times Tfa)}{Trb - Tra - Tfa + Tfb}$$

Where:

Tcp = Crossing Point

Tra, Trb, Tfa and Tfb are time measurements with respect to the input.

Switching Time Waveforms



AC Test Circuits and Switching Waveforms

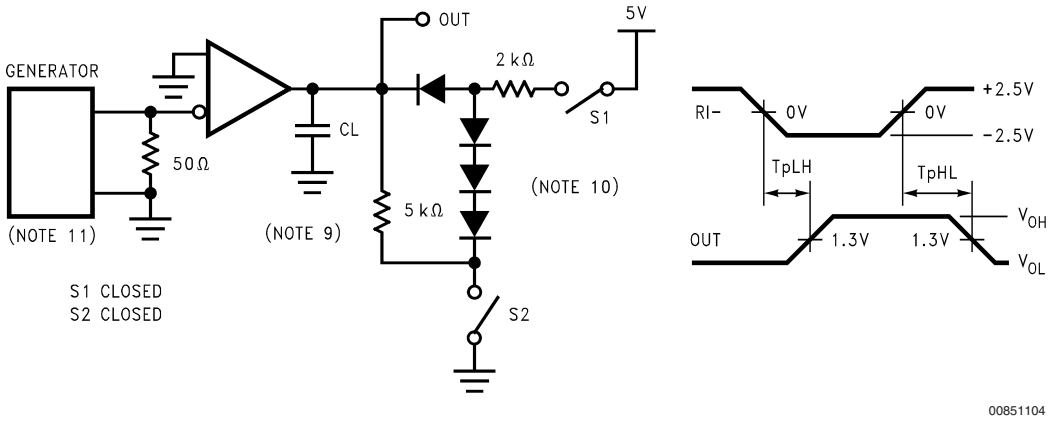


FIGURE 1.

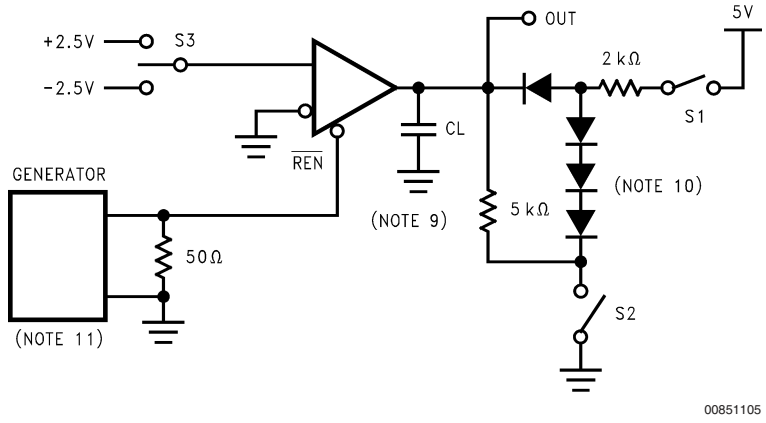
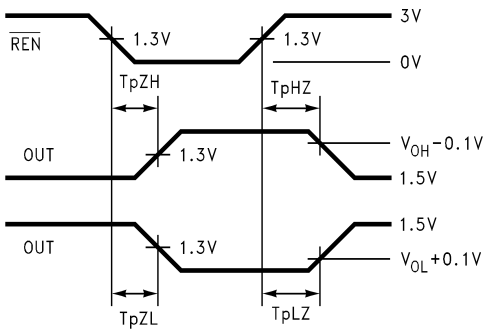


FIGURE 2.

AC Test Circuits and Switching Waveforms (Continued)



	S1	S2	S3
T_{PLZ}	Closed	Open	+2.5V
T_{PHZ}	Open	Closed	−2.5V
T_{PZL}	Closed	Open	+2.5V
T_{PZH}	Open	Closed	−2.5V

FIGURE 3.

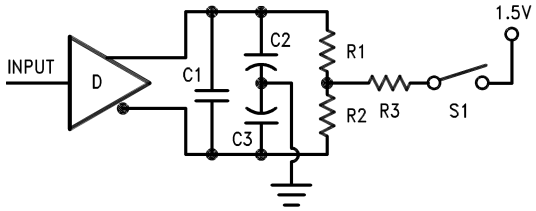


FIGURE 4.

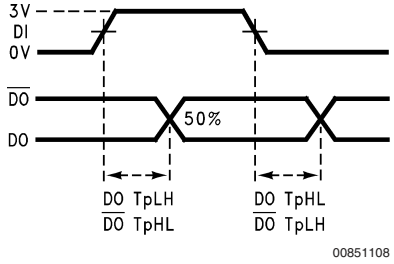


FIGURE 5.

AC Test Circuits and Switching Waveforms (Continued)

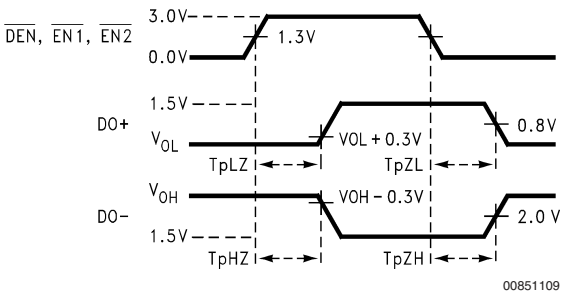


FIGURE 6.

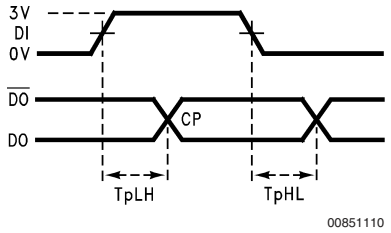


FIGURE 7.

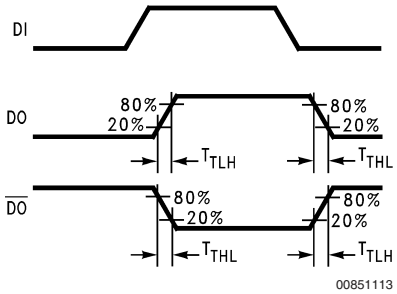
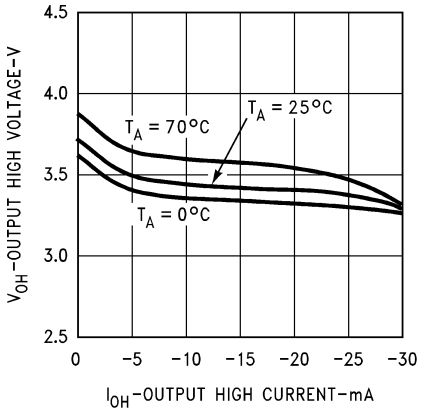


FIGURE 8.

Typical Performance Characteristics (DS8923A)

Driver V_{OH} vs I_{OH} vs Temperature



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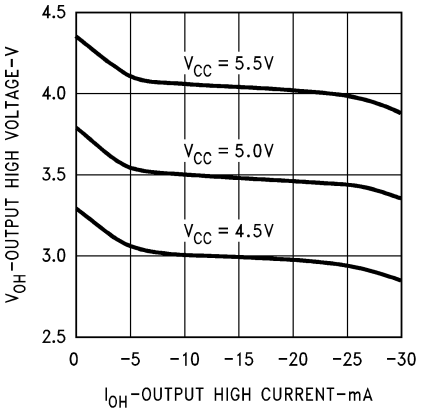
Driver V_{OH} vs I_{OH} vs V_{CC}



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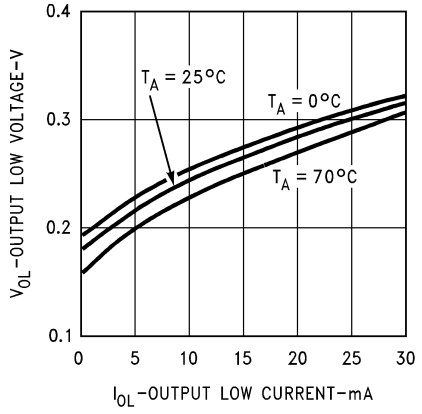
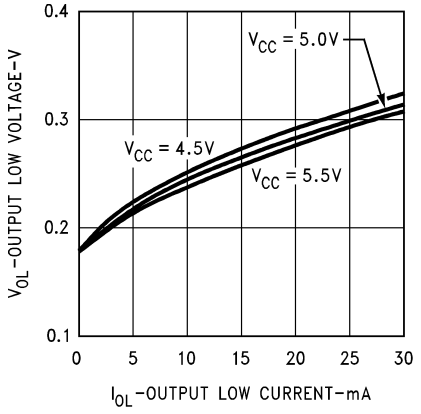
Driver V_{OL} vs I_{OL} vs Temperature



00851116

Driver V_{OL} vs I_{OL} vs V_{CC}



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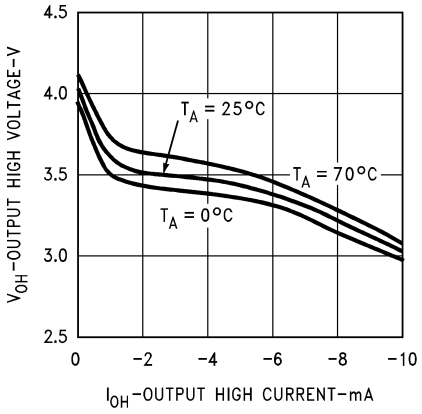
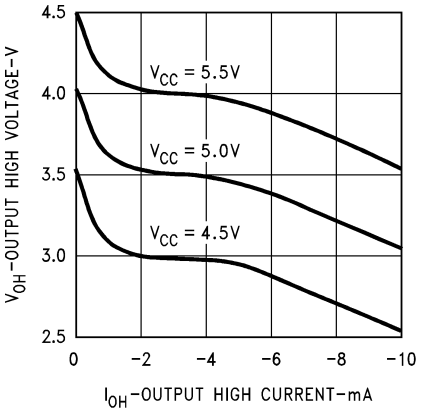
Receiver V_{OH} vs I_{OH} vs Temperature



00851118

Receiver V_{OH} vs I_{OH} vs V_{CC}



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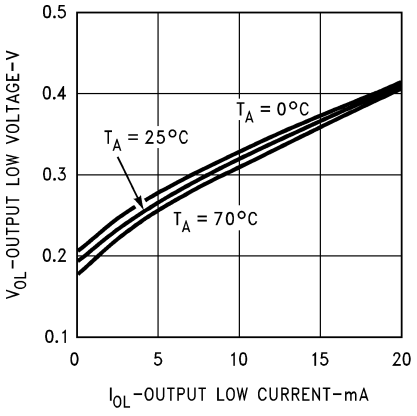
Typical Performance Characteristics (DS8923A) (Continued)

Receiver V_{OL} vs I_{OL} vs Temperature



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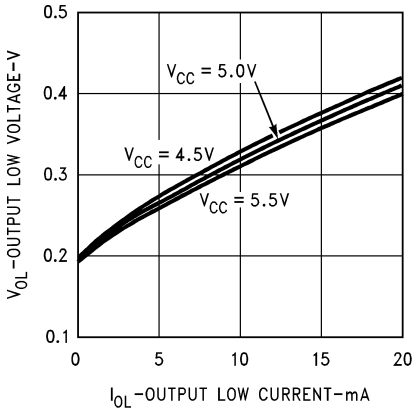
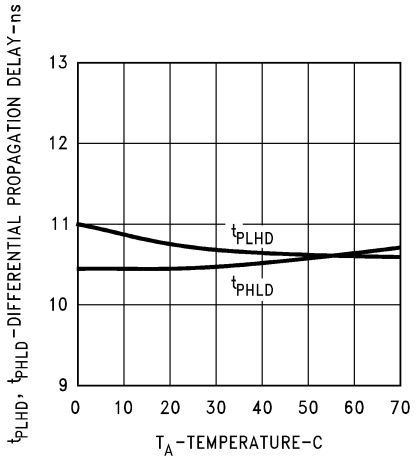
Receiver V_{OL} vs I_{OL} vs V_{CC}



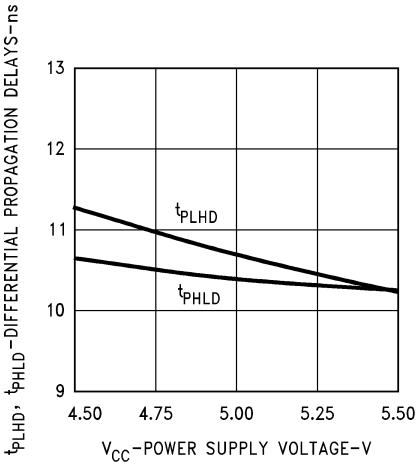
00851121

Driver Differential Propagation Delay vs Temperature



00851122

Driver Differential Propagation Delay vs V_{CC}



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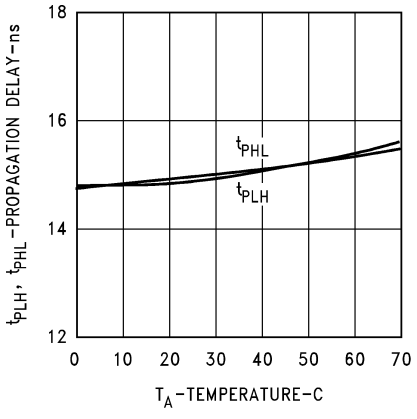
Receiver Propagation Delay vs Temperature



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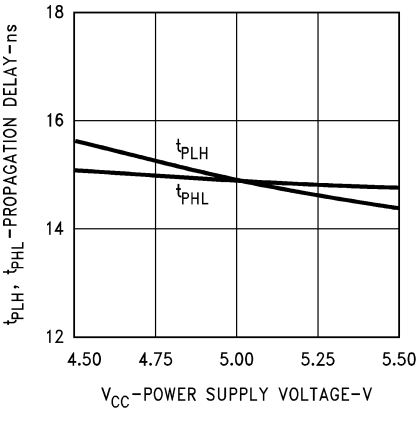
Receiver Propagation Delay vs V_{CC}



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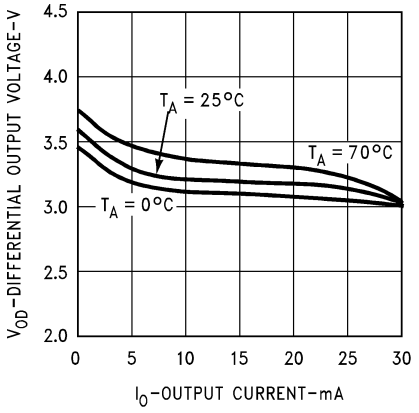
Typical Performance Characteristics (DS8923A) (Continued)

Driver V_{OD} vs Temperature



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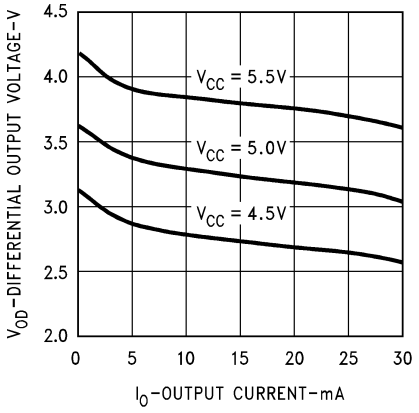
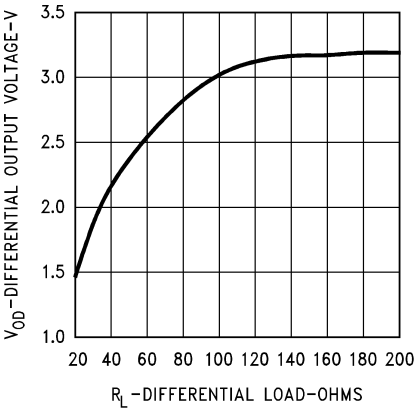
Driver V_{OD} vs V_{CC}



00851127

Driver V_{OD} vs R_L



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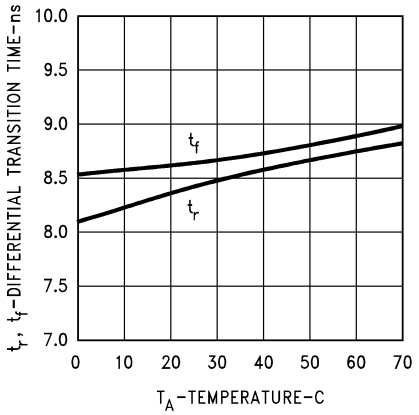
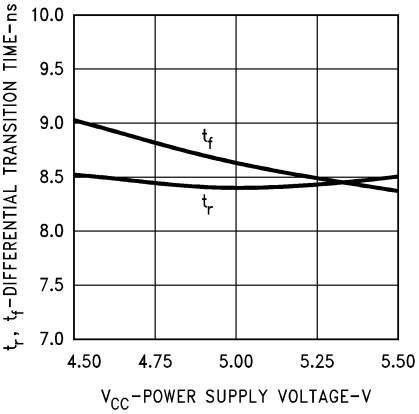
Driver Differential Transition Time vs Temperature



00851129

Driver Differential Transition Time vs V_{CC}



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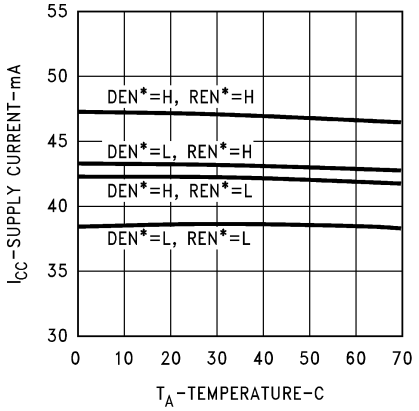
Supply Current vs Temperature



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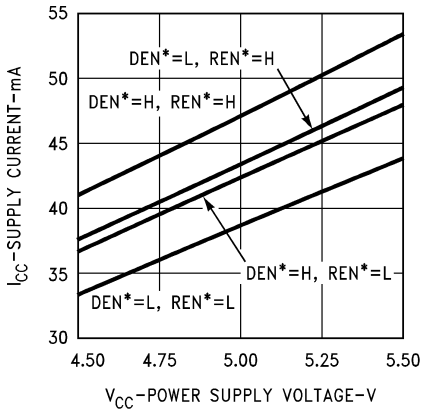
Typical Performance Characteristics (DS8923A) (Continued)

Supply Current vs V_{CC}



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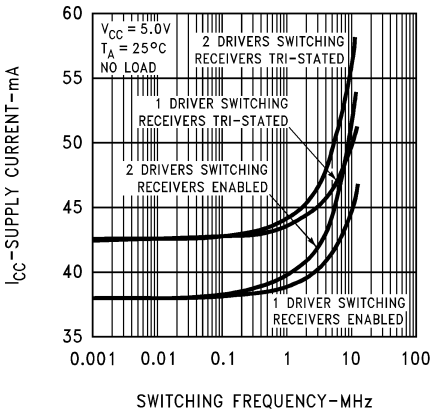
I_{CC} vs Driver Switching Frequency



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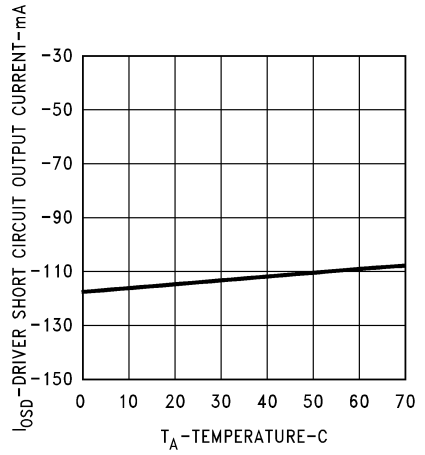
Driver Short Circuit Current vs Temperature



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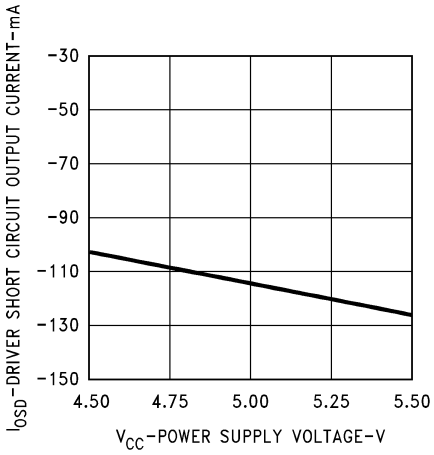
Driver Short Circuit Current vs V_{CC}



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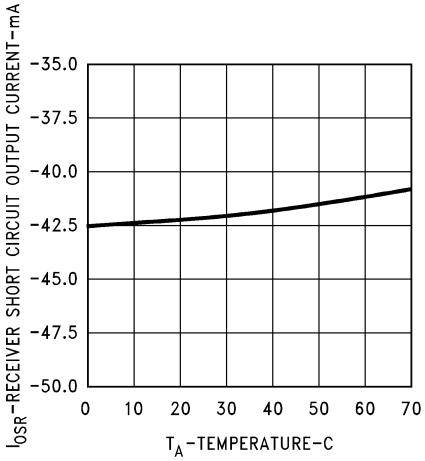
Receiver Short Circuit Current vs Temperature



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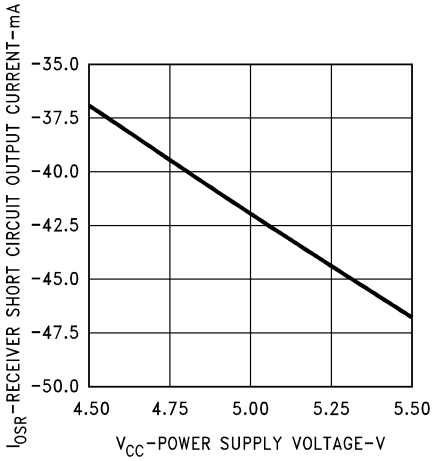
Receiver Short Circuit Current vs V_{CC}



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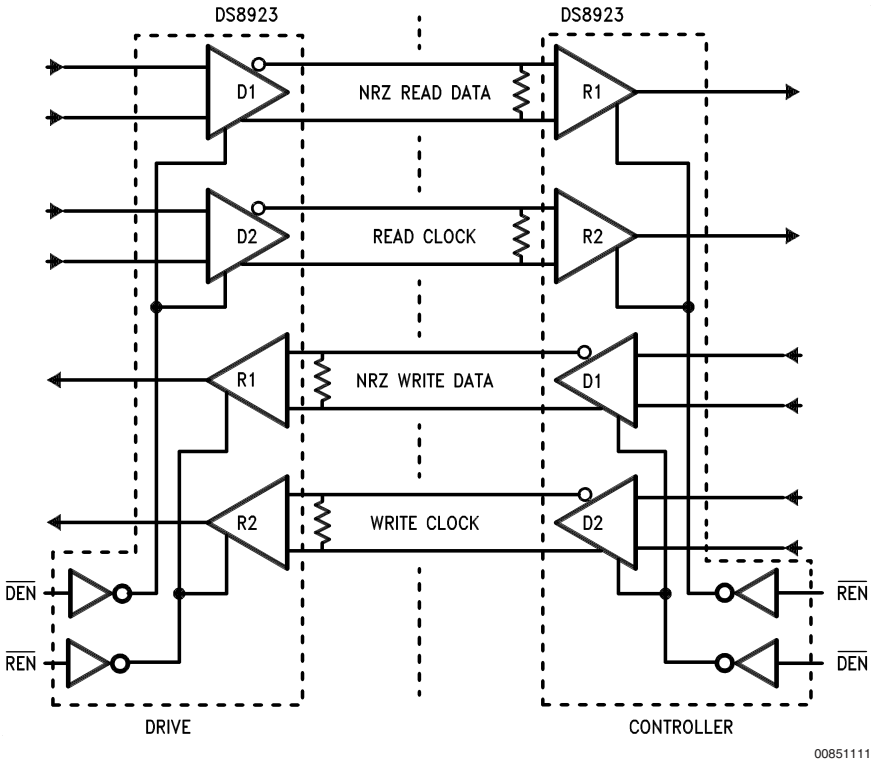
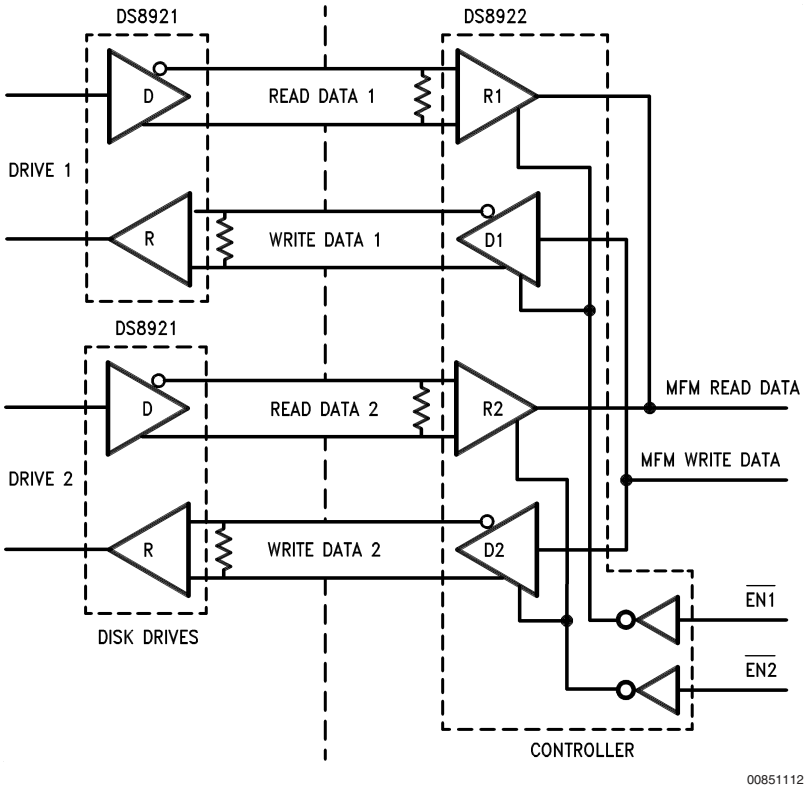
Typical Applications

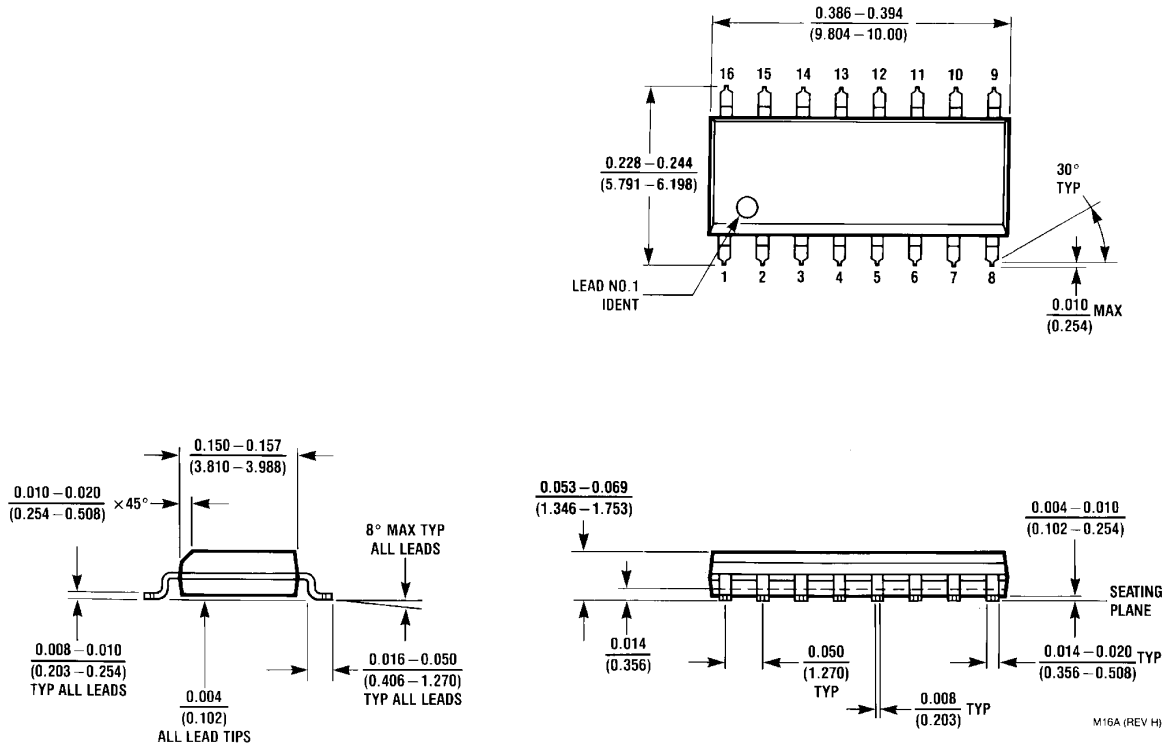
ESDI Application



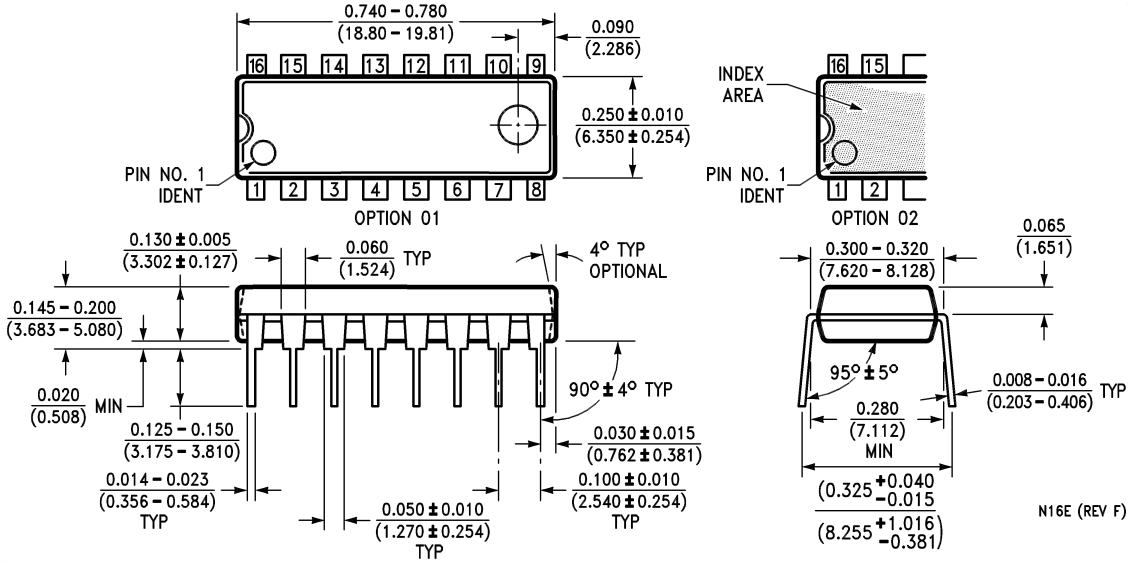
ST504 and ST412 Applications



Physical Dimensions inches (millimeters) unless otherwise noted



SO Package (M)
Order Number DS8922M, DS8922AM, or DS8923AM
NS Package Number M16A



Molded Dual-In-Line Package (N)
Order Number DS8922N, DS8922AN, or DS8923AN
NS Package Number N16E

Notes

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

BANNED SUBSTANCE COMPLIANCE

National Semiconductor certifies that the products and packing materials meet the provisions of the Customer Products Stewardship Specification (CSP-9-111C2) and the Banned Substances and Materials of Interest Specification (CSP-9-111S2) and contain no ''Banned Substances'' as defined in CSP-9-111S2.

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